

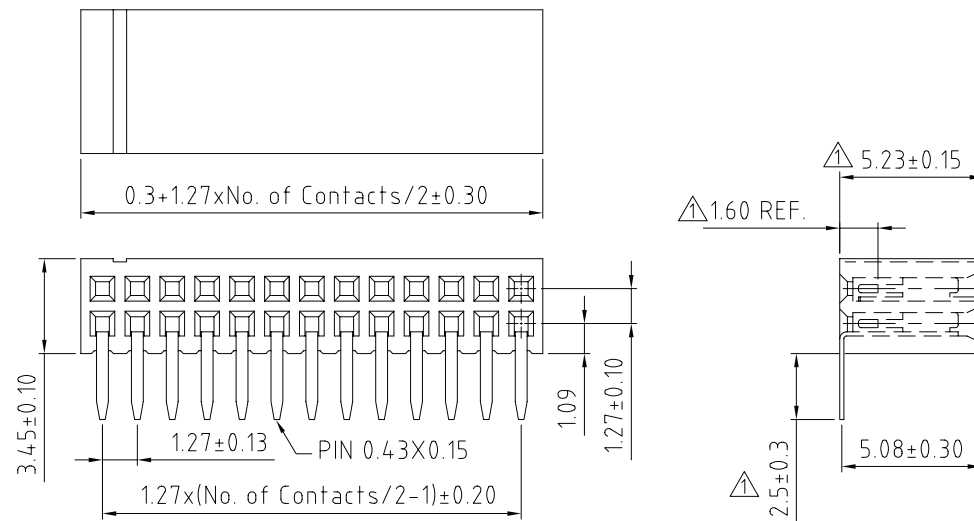
SPECIFICATIONS

CURRENT RATING	1 AMPS
INSULATOR RESISTANCE	1000 MEGOHMS MIN.
DIELECTRIC WITHSTANDING	AC 500 V
OPERATING TEMPERATURE	-40°C TO +105°C
CONTACT MATERIAL	PHOSPHOR BRONZE
INSULATOR MATERIAL	POLYESTER UL 94V-0
	STANDARD NYLON 6T
PLATING	GOLD OR TIN OVER 30~50U" NICKEL
SOLDERABILITY	IR REFLOW: 260°C FOR 10 SEC
	WAVE: 230°C FOR 5-10 SEC
	MANNUAL SOLDER: 350°C FOR 3-5SEC

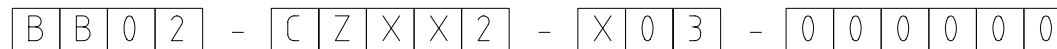
NOTES:

1. PACKED IN TUBE.
2. RECOMMENDED MATING PIN LENGTH: 3.5MM.

MATES WITH: BB02-BC BB02-NE
BB02-BD
BB02-BK
BB02-BP
BB02-BS



HOW TO ORDER



NO. OF CONTACTS
06 TO 80

CONTACT PLATING OPTIONS

K = GOLD FLASH (STANDARD)

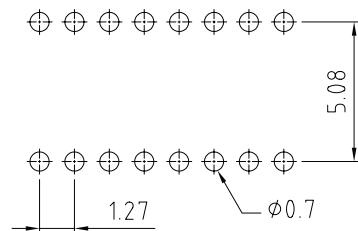
A = 10U" GOLD ON CONTACT/GOLD FLASH ON TAIL

B = 15U" GOLD ON CONTACT/GOLD FLASH ON TAIL



C = 30U" GOLD ON CONTACT/GOLD FLASH ON TAIL

T = BRIGHT TIN

M = MATT TIN



RECOMMENDED PC BOARD SMD LAYOUT

Scale: 5:1		Unstated Tolerances: X. ± 0.30 X ± 0.25 XX ± 0.15 .XXX ± 0.10	Material SEE NOTE		Type: BB02-CZ	
Drawn: CHC					BB02-CZ	
App'd: XXXX	Title: SOCKET	NOT TO SCALE	Drawing Number:			
Date: 29 DEC '08	Revision: 1.4	Unit: mm	Sheet 1 of 1			
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